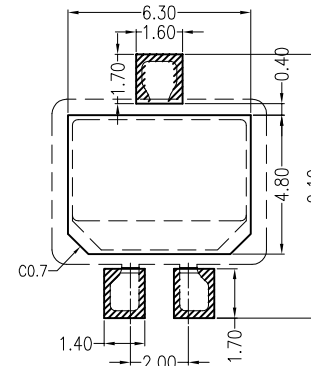
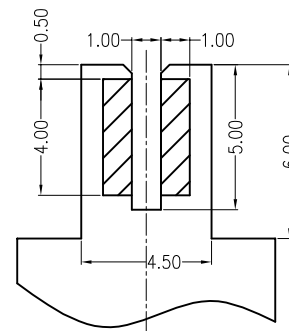
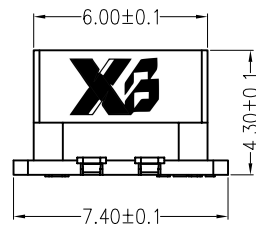
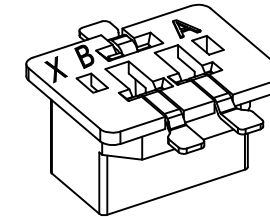
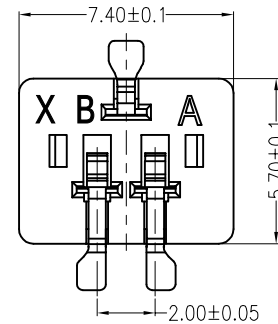
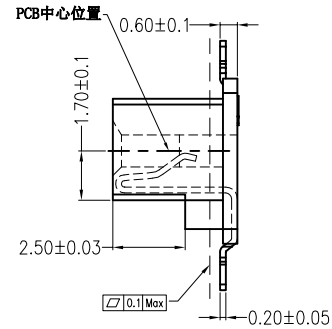
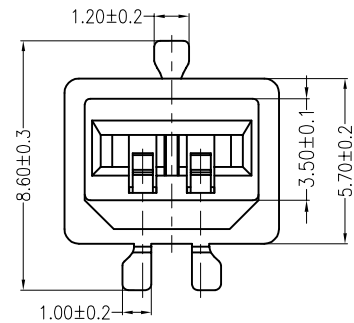


REV	DESCRIPTION	DESIGN	DATE
A0	Release	吴丹平	2016.04.30



主要技术参数 Main Specifications

板 厚 (thickness): 1.0mm
接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$
绝缘电阻 (Insulation resistance): $\geq 1000\text{M}\Omega$
额定电压 (Rated voltage): 125V AC DC
额定电流 (Rated current): 1.0A AC DC
耐 电 压 (Withstand Voltage): 800V AC/minute
温度范围 (Temperature Range): $-40^{\circ}\text{C} \sim +120^{\circ}\text{C}$

ORDER INFORMATION:

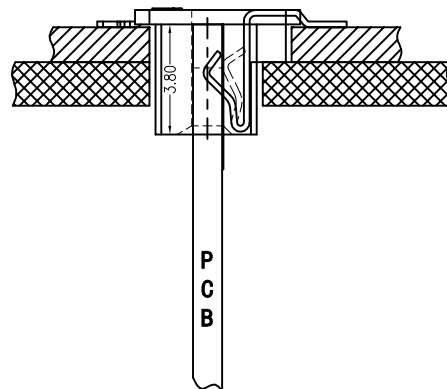
XB-L038-02-F2MB-R

PART No. _____
No. FOR CIRCUITS: _____
02
PLASTIC MATERIAL: _____
F2M=LCP (BEIGE)

PACKAGING:
P=PE
R=REEL
PLATING:
B=MATTE Sn

Mating PCB detail

Board Layout



Assembly Layout

C	Solder Tab	1 PCS	Brass	MATTE Sn-plated
B	CONTACT	2 PCS	PhosphorBronze	MATTE Sn-plated
A	PEDESTAL	1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
东莞市溪榜电子有限公司 Switch Connector DONG GUAN XI BANG ELECTRONICS CO., LTD		TITLE: - 2.0mmPITCH 180°WAFER SMT TYPE		
X.±0.5	X.±5°	USE: CUSTOMER		PART NO.: L038-02-F2MB-R
.X±0.3	.X±2°	APPD: 邵敬和		DWG NO.: GCCP-0063
.XX±0.25	.XX±1°	CHKD: 田峰		SCALE 1 : 1
--	--	DR: 周秀龙		SHEET 1 / 1
	UNITS: mm			